



## SOITEC ISO 9001 CERTIFICATION EXPANDED TO GROUP'S WORLDWIDE OPERATIONS

Corporate quality management system increases efficiency  
and ensures alignment across manufacturing sites

Bernin, France — March 2, 2009 — Soitec (*Euronext Paris*), the world's leading supplier of silicon-on-insulator (SOI) wafers and other engineered substrates used for the microelectronics industry, today announced that the Group has been awarded the *International Standards Organization (ISO) 9001* certification for quality assurance. The Group was audited by the renowned worldwide *Lloyd's Register Quality Assurance (LRQA)* organization, both for a renewal at the headquarters in France and a first certification in Singapore. To ensure global standardization, all group activities will now be managed through a corporate quality management system. Soitec's compliance with internationally recognized quality management practices underscores the Group's continued efforts to increase efficiency and alignment across its operating sites.

“This certification demonstrates Soitec Group's commitment to customer satisfaction and to delivering excellence in all areas of operations worldwide. As an international technology leader, we rely on strong internal processes to drive our business and support our mission to continue delivering the most innovative products, and meeting the increasing quality standards of the micro-electronics industry,” said Jean-Luc Ledys, VP of corporate quality for the Soitec Group.

ISO 9001 is an internationally recognized standard that ensures the highest quality products and services based on established, verifiable procedures. Now the entire group holds the globally-recognized certification for having established a high-level process and system-oriented quality management (QM) based on ISO 9001 standards. Soitec's plant in Bernin, France received its first certification in 1998. The Picogiga site based in Les Ulis currently holds its own ISO certification and will be integrated in the certification group subsequently.

### **About the Soitec Group:**

The Soitec Group is the world's leading innovator and provider of the engineered substrate solutions that serve as the foundation for today's most advanced microelectronic products. The group leverages its proprietary Smart Cut™ technology to engineer new substrate solutions, such as silicon-on-insulator (SOI) wafers, which became the first high-volume application for this proprietary technology. Since then, SOI has emerged as the material platform of the future, enabling the production of higher performing, faster chips that consume less power.

Today, Soitec produces more than 80 percent of the world's SOI wafers. Headquartered in Bernin, France, with two high-volume fabs on-site, Soitec has offices throughout the United States, Japan and Taiwan, and a new production site in the process of customers' qualification in Singapore.

Two other divisions, Picogiga International (Les Ulis) and Tracit Technologies (Bernin), complete the Soitec Group. Picogiga focuses on delivering advanced substrates solutions, including III-V epiwafers and gallium nitride (GaN)-based wafers, to the compound material world for the manufacture of high-frequency electronics and other optoelectronic devices. Tracit, on the other hand, focuses on thin-film layer transfer technologies used to manufacture advanced substrates for power ICs and microsystems, as well as generic circuit transfer technology for applications such as image sensors and 3D-integration. Shares of the Soitec Group are listed on Euronext Paris. For more information, visit [www.soitec.com](http://www.soitec.com).

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